

HCPL2630 DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR

SOOS010 D2969, NOVEMBER 1986

- Gallium Arsenide Phosphide LED Optically Coupled to an Integrated Circuit Detector
- Compatible with TTL and LSTTL Inputs
- Low Input Current Required for On-State Output . . . 5 mA Max
- High-Voltage Electrical Insulation . . . 3000 V DC Min
- High-Speed Switching . . . 75 ns Max
- Directly Interchangeable with Hewlett Packard HCPL2630
- UL Recognized . . . File Number E65085

description

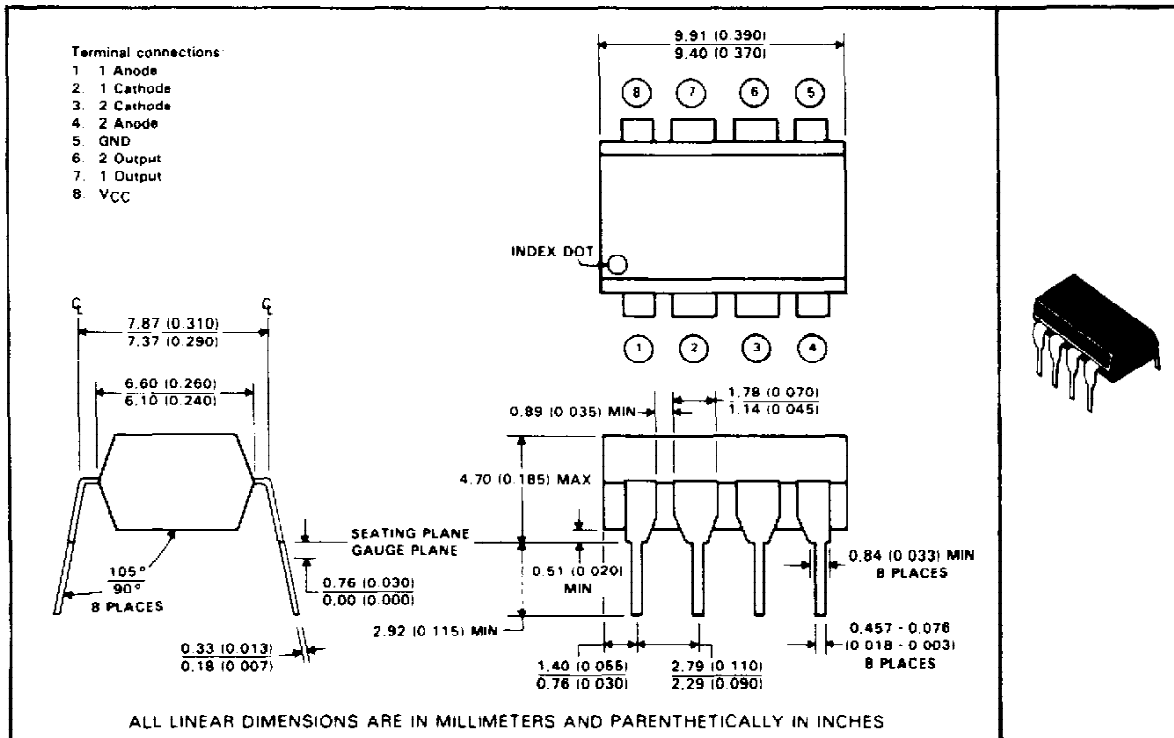
The HCPL2630 is a dual optocoupler designed for use in high-speed digital interfacing applications that require high-voltage isolation between the input and output. Applications include line receivers, microprocessors or computer interface, and other control systems.

Each channel of the HCPL2630 optocoupler consists of a GaAsP light-emitting diode and an integrated light detector composed of a photodiode, a high-gain amplifier, and a Schottky-clamped open-collector output transistor. An input diode forward current of 5 milliamperes will switch the output transistor low, providing an on-state drive current of 13 milliamperes (eight 1.6-milliamperes TTL loads).

The device is mounted in a standard 8-pin dual-in-line plastic package.

The HCPL2630 is characterized for operation over the temperature range of 0°C to 70°C.

mechanical data



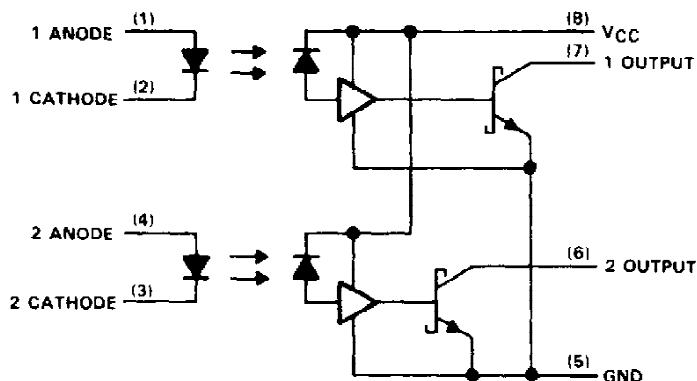
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

TEXAS
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HCPL2630 **DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR**

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC}	7 V
Reverse input voltage	5 V
Output voltage	7 V
Peak forward input current, each channel (≤ 1 ms duration)	30 mA
Average forward input current, each channel	15 mA
Output current, each channel	16 mA
Output power dissipation	85 mW
Storage temperature range	-55°C to 125°C
Operating free-air temperature range	0°C to 70°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	Output supply voltage (see Note 1)	4.5	5	5.5	V
$I_{F(on)}$	Input forward current to turn output on	6.3		15	mA
$I_{F(off)}$	Input forward current to turn output off	0		250	μA
I_{OL}	Low-level (on-state) output current			13	mA
T_A	Operating free-air temperature	0		70	$^{\circ}\text{C}$

NOTE 1: All voltage values are with respect to GND (pin 5).

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DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
V _F	Input forward voltage	I _F = 10 mA, T _A = 25°C	1.6	1.75	V
α _{VF}	Temperature coefficient of forward voltage	I _F = 10 mA	-1.8		mV/°C
V _{BR}	Input reverse breakdown voltage	I _R = 10 μA, T _A = 25°C	5		V
V _{OL}	Low-level output voltage	V _{CC} = 5.5 V, I _F = 5 mA, I _{OL} = 13 mA	0.23	0.6	V
I _{OH}	High-level output current	V _{CC} = 5.5 V, V _O = 5.5 V, I _F = 250 μA		250	μA
I _{CC} H	Supply current, high-level output	V _{CC} = 5.5 V, I _F = 0	20	30	mA
I _{CC} L	Supply current, low-level output	V _{CC} = 5.5 V, I _F = 10 mA	26	36	mA
I _{II}	Input-input insulation leakage current	V _{II} = 500 V, t = 5 s, T _A = 25°C, RH = 45%, See Note 2	0.005		μA
I _{IO}	Input-output insulation leakage current	V _{IO} = 3000 V, t = 5 s, T _A = 25°C, RH = 45%, See Note 1		1	μA
r _{II}	Input-input resistance	V _{II} = 500 V, T _A = 25°C, See Note 2	10 ¹¹		Ω
r _{IO}	Input-output resistance	V _{IO} = 500 V, T _A = 25°C, See Note 1	10 ¹²		Ω
C _i	Input capacitance	V _F = 0, f = 1 MHz	60		pF
C _{II}	Input input capacitance	V _F = 0, f = 1 MHz	0.25		pF
C _{IO}	Input-output capacitance	f = 1 MHz, T _A = 25°C, See Note 1	0.6		pF

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTES 1. These parameters are measured between pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together.
2. These parameters are measured between pins 1 and 2 shorted together and pins 3 and 4 shorted together.

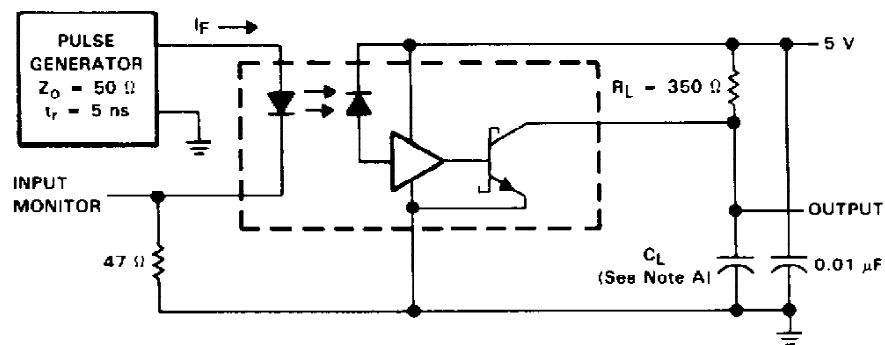
switching characteristics at V_{CC} = 5 V, T_A = 25°C

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	Propagation delay time, low-to-high-level output, from LED input	I _F = 7.5 mA, R _L = 350 Ω, C _L = 15 pF, See Figure 1	42	75	ns
t _{PHL}	Propagation delay time, high-to-low level output, from LED input	I _F = 7.5 mA, R _L = 350 Ω, C _L = 15 pF, See Figure 1	42	75	ns
t _r	Rise time	I _F = 7.5 mA, R _L = 350 Ω, C _L = 15 pF	20		ns
t _f	Fall time	I _F = 7.5 mA, R _L = 350 Ω, C _L = 15 pF	30		ns
$\frac{dV_{CM}}{dt}$ (H)	Common-mode input transient immunity, high-level output	ΔV _{CM} = 10 V, I _F = 0, R _L = 350 Ω, See Note 3 and Figure 2	50		V/μs
$\frac{dV_{CM}}{dt}$ (L)	Common-mode input transient immunity, low-level output	ΔV _{CM} = -10 V, I _F = 5 mA, R _L = 350 Ω, See Note 3 and Figure 2	-150		V/μs

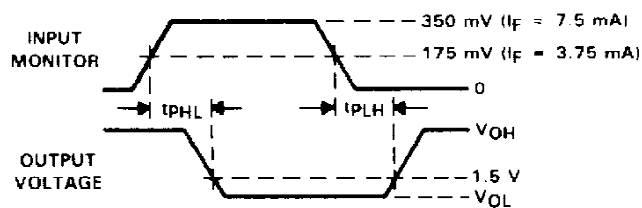
NOTE 3: Common-mode input transient immunity, high-level output, is the maximum rate of rise of the common-mode input voltage that does not cause the output voltage to drop below 2 V. Common-mode input transient immunity, low-level output, is the maximum rate of fall of the common-mode input voltage that does not cause the output voltage to rise above 0.8 V.

HCPL2630 DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR

PARAMETER MEASUREMENT INFORMATION (EACH CHANNEL)



TEST CIRCUIT



WAVEFORMS

NOTE A: C_L is approximately 15 pF, which includes probe and stray wiring capacitances.

FIGURE 1. t_{PLH} AND t_{PLH} FROM LED INPUT TEST CIRCUIT AND WAVEFORMS

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PARAMETER MEASUREMENT INFORMATION **(EACH CHANNEL)**

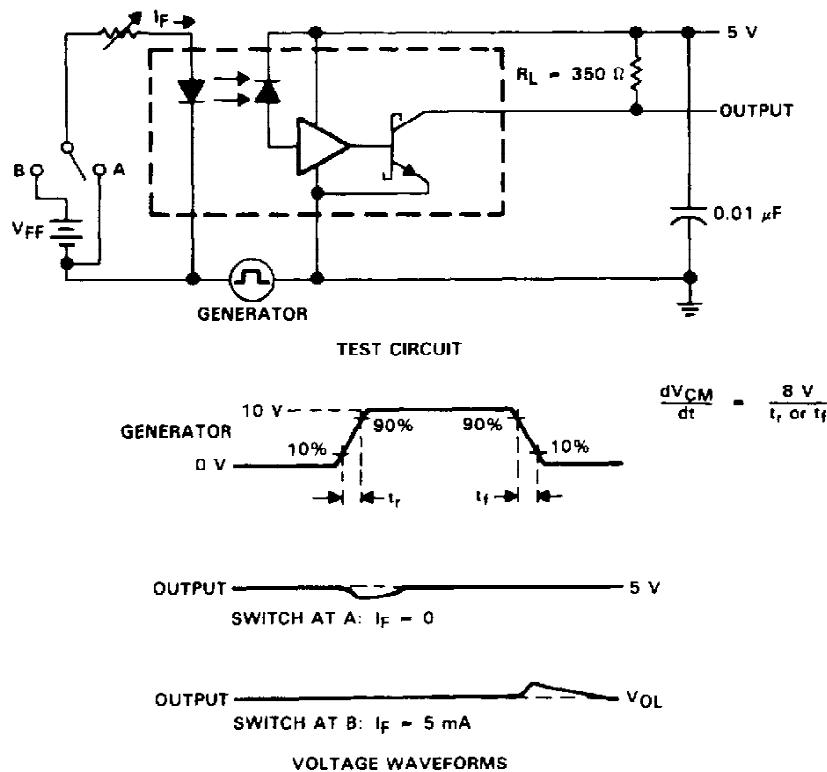
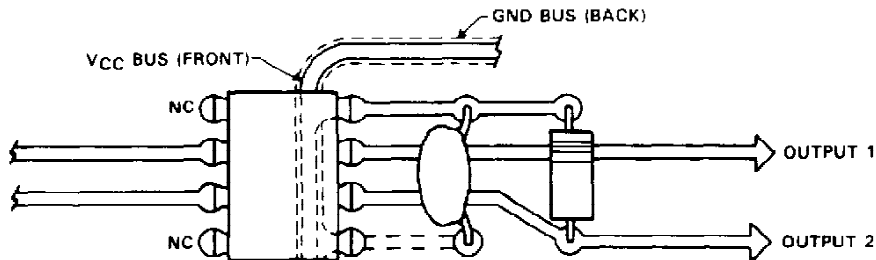


FIGURE 2. TRANSIENT IMMUNITY TEST CIRCUIT AND WAVEFORMS

TYPICAL APPLICATION INFORMATION

A ceramic capacitor (0.01 μF to 0.1 μF) should be connected between pins 8 and 5 to stabilize the high-gain amplifier. The total lead length between the capacitor and the optocoupler should not exceed 20 mm (0.8 inches). Failure to provide a bypass capacitor may result in impaired switching characteristics.



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TYPICAL CHARACTERISTICS

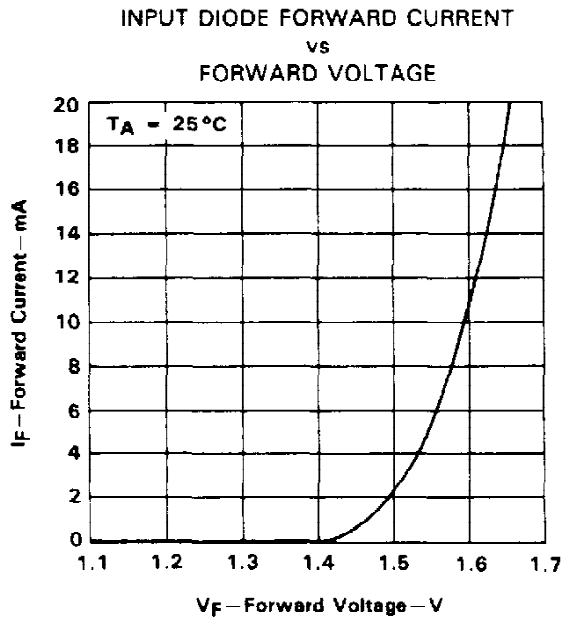


FIGURE 4

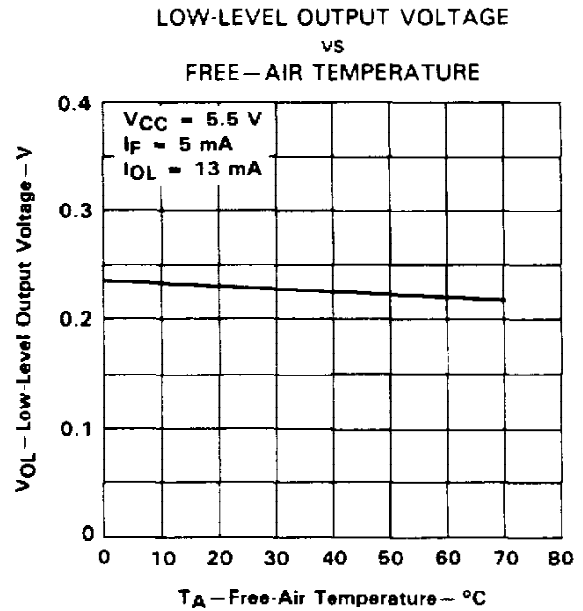


FIGURE 5

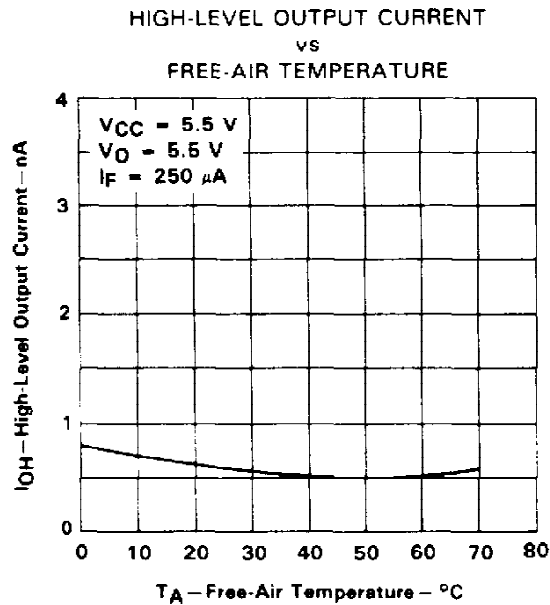


FIGURE 6

HCPL2630
DUAL-CHANNEL OPTOCOUPLER/OPTOISOLATOR

TYPICAL CHARACTERISTICS

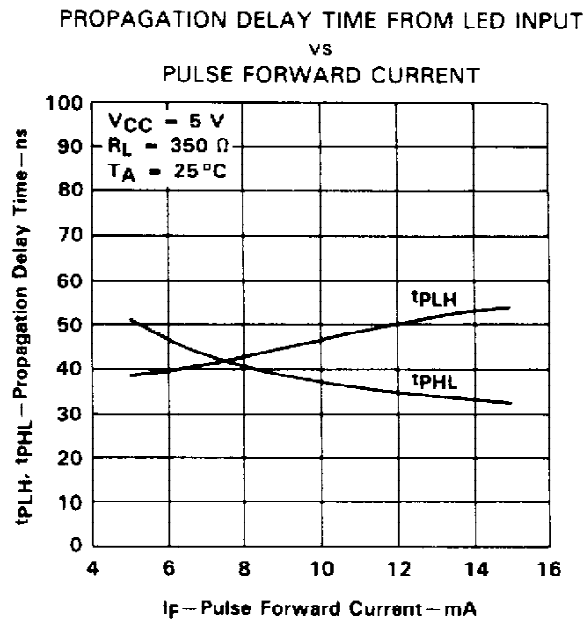


FIGURE 7

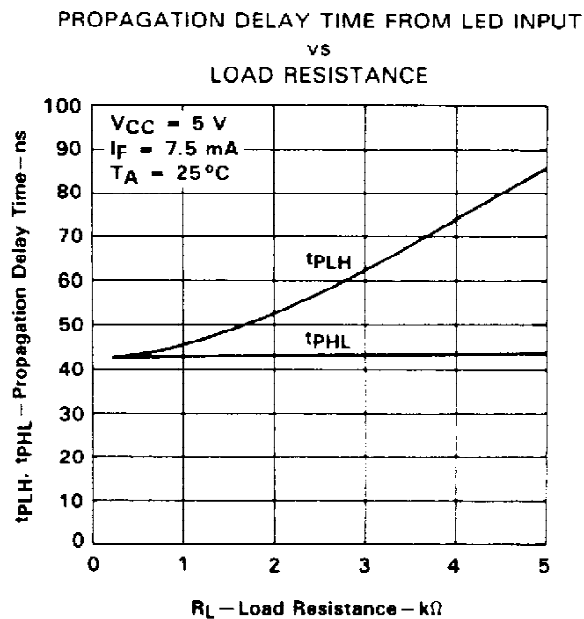


FIGURE 8

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
HCPL2630	OBSOLETE	PDIP	N	8		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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